# **Dual General Purpose Transistors**

# **NPN Duals**

These transistors are designed for general purpose amplifier applications. They are housed in the SOT-363/SC-88 which is designed for low power surface mount applications.

#### **Features**

- S and NSV Prefixes for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant\*

#### **MAXIMUM RATINGS**

| Rating                            | Symbol           | BC846 | BC847 | BC848 | Unit |
|-----------------------------------|------------------|-------|-------|-------|------|
| Collector - Emitter Voltage       | V <sub>CEO</sub> | 65    | 45    | 30    | V    |
| Collector - Base Voltage          | V <sub>CBO</sub> | 80    | 50    | 30    | V    |
| Emitter-Base Voltage              | V <sub>EBO</sub> | 6.0   | 6.0   | 5.0   | V    |
| Collector Current –<br>Continuous | I <sub>C</sub>   | 100   | 100   | 100   | mAdc |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL CHARACTERISTICS

| Characteristic  | Symbol                            | Max               | Unit     |
|---|-----------------------------------|-------------------|----------|
| Total Device Dissipation Per Device FR-5 Board (Note 1) T <sub>A</sub> = 25°C Derate Above 25°C | P <sub>D</sub>                    | 380<br>250<br>3.0 | mW<br>mW |
| Thermal Resistance, Junction to Ambient   | $R_{\theta JA}$                   | 328               | °C/W     |
| Junction and Storage Temperature Range  | T <sub>J</sub> , T <sub>stg</sub> | -55 to +150       | °C       |

1.  $FR-5 = 1.0 \times 0.75 \times 0.062$  in

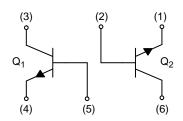


# ON Semiconductor®

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SOT-363/SC-88 CASE 419B STYLE 1



#### **MARKING DIAGRAM**



1x = Specific Device Code

x = B, F, G, L

M = Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

<sup>\*</sup>For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

Symbol

Min

Тур

Max

Unit

# **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic

**OFF CHARACTERISTICS** 

| Collector – Emitter Breakdown Voltage  | V <sub>(BR)CEO</sub>  |                      |                          |                      | V        |
|--|-----------------------|----------------------|--------------------------|----------------------|----------|
| (I <sub>C</sub> = 10 mA)<br>BC846<br>BC847<br>BC848  |                       | 65<br>45<br>30       | -<br>-<br>-              | -<br>-<br>-          |          |
| Collector – Emitter Breakdown Voltage (I <sub>C</sub> = 10 µA, V <sub>EB</sub> = 0) BC846 BC847 BC848  | V <sub>(BR)CES</sub>  | 80<br>50<br>30       | -<br>-<br>-              | -<br>-<br>-          | V        |
| Collector – Base Breakdown Voltage  (I <sub>C</sub> = 10 μA)  BC846  BC847  BC848  | V <sub>(BR)</sub> CBO | 80<br>50<br>30       | -<br>-<br>-              | -<br>-<br>-          | V        |
| Emitter-Base Breakdown Voltage (I <sub>E</sub> = 1.0 μA) BC846 BC847 BC848   | V <sub>(BR)EBO</sub>  | 6.0<br>6.0<br>5.0    | -<br>-<br>-              | -<br>-<br>-          | V        |
| Collector Cutoff Current $(V_{CB} = 30 \text{ V})$ $(V_{CB} = 30 \text{ V}, T_A = 150^{\circ}\text{C})$  | I <sub>CBO</sub>      | <u>-</u><br>-        | -<br>-                   | 15<br>5.0            | nA<br>μA |
| ON CHARACTERISTICS   |                       |                      |                          |                      |          |
| DC Current Gain $ \begin{aligned} &(I_C = 10 \ \mu\text{A}, \ V_{CE} = 5.0 \ \text{V}) \\ & \text{BC846B}, \ \text{BC847B} \\ & \text{BC847C}, \ \text{BC848C} \end{aligned} $ $ &(I_C = 2.0 \ \text{mA}, \ V_{CE} = 5.0 \ \text{V}) \\ & \text{BC846B}, \ \text{BC847B} \\ & \text{BC847C}, \ \text{BC848C} \end{aligned} $ | h <sub>FE</sub>       | -<br>-<br>200<br>420 | 150<br>270<br>290<br>520 | -<br>-<br>450<br>800 | -        |
| Collector – Emitter Saturation Voltage ( $I_C = 10 \text{ mA}, I_B = 0.5 \text{ mA}$ ) ( $I_C = 100 \text{ mA}, I_B = 5.0 \text{ mA}$ )  | V <sub>CE(sat)</sub>  | -<br>-               | -<br>-                   | 0.25<br>0.6          | V        |
| Base – Emitter Saturation Voltage $(I_C = 10 \text{ mA}, I_B = 0.5 \text{ mA})$ $(I_C = 100 \text{ mA}, I_B = 5.0 \text{ mA})$   | V <sub>BE(sat)</sub>  | -<br>-               | 0.7<br>0.9               | -<br>-               | V        |
| Base – Emitter Voltage $(I_C = 2.0 \text{ mA}, V_{CE} = 5.0 \text{ V})$ $(I_C = 10 \text{ mA}, V_{CE} = 5.0 \text{ V})$  | V <sub>BE(on)</sub>   | 580<br>-             | 660<br>-                 | 700<br>770           | mV       |
| SMALL-SIGNAL CHARACTERISTICS   |                       |                      |                          |                      |          |
| Current – Gain – Bandwidth Product<br>(I <sub>C</sub> = 10 mA, V <sub>CE</sub> = 5.0 Vdc, f = 100 MHz)   | f <sub>T</sub>        | 100                  | -                        | _                    | MHz      |
| Output Capacitance<br>(V <sub>CB</sub> = 10 V, f = 1.0 MHz)  | C <sub>obo</sub>      | -                    | -                        | 4.5                  | pF       |
| Noise Figure   | NF                    |                      |                          | 10                   | dB       |

#### **TYPICAL CHARACTERISTICS - BC846BDW1**

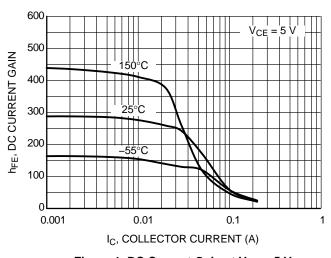


Figure 1. DC Current Gain at  $V_{CE} = 5 \text{ V}$ 

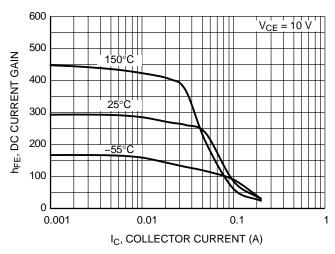


Figure 2. DC Current Gain at  $V_{CE} = 10 \text{ V}$ 

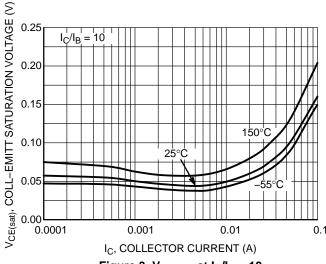


Figure 3.  $V_{CE(sat)}$  at  $I_C/I_B = 10$ 

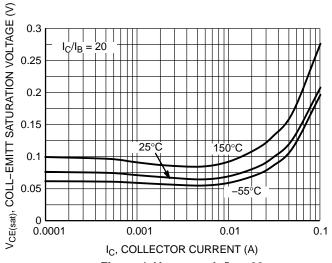
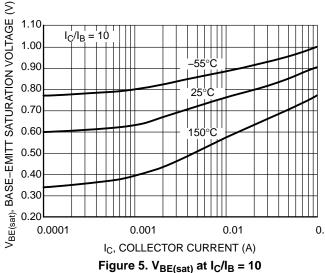


Figure 4.  $V_{CE(sat)}$  at  $I_C/I_B = 20$ 



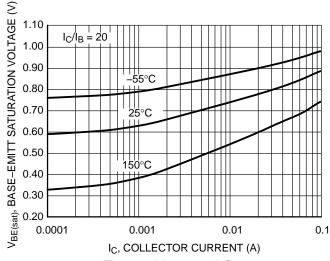


Figure 6.  $V_{BE(sat)}$  at  $I_C/I_B = 20$ 

#### **TYPICAL CHARACTERISTICS - BC846BDW1**

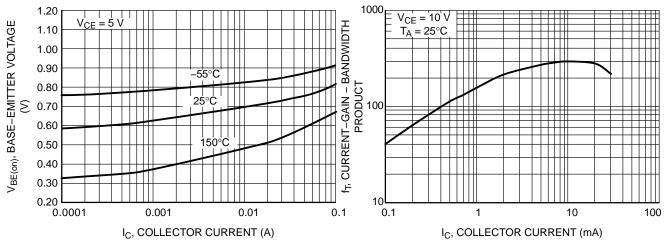


Figure 7.  $V_{BE(on)}$  at  $V_{CE} = 5 \text{ V}$ 

Figure 8. Current - Gain - Bandwidth Product

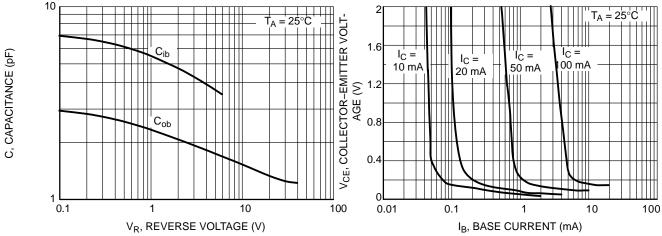


Figure 9. Capacitances

Figure 10. Collector Saturation Region

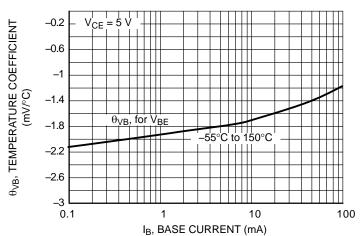
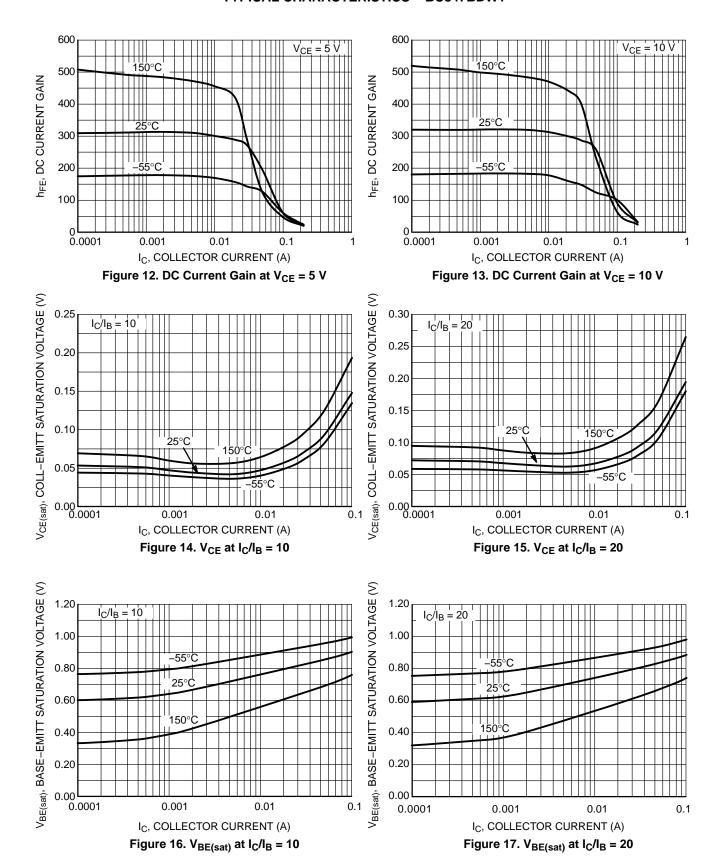


Figure 11. Base-Emitter Temperature Coefficient

#### **TYPICAL CHARACTERISTICS - BC847BDW1**



#### **TYPICAL CHARACTERISTICS - BC847BDW1**

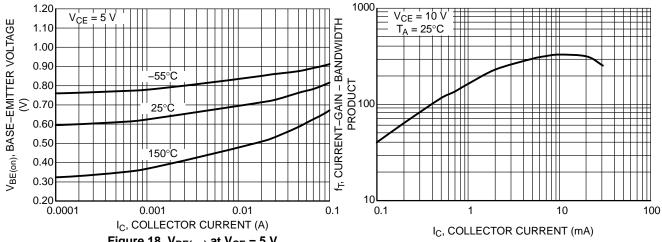


Figure 18.  $V_{BE(on)}$  at  $V_{CE} = 5 \text{ V}$ 

Figure 19. Current – Gain – Bandwidth Product

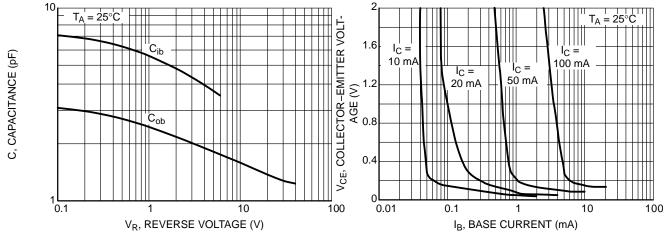


Figure 20. Capacitances

Figure 21. Collector Saturation Region

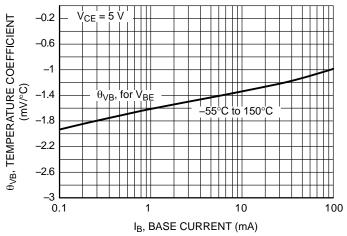


Figure 22. Base-Emitter Temperature Coefficient

#### **TYPICAL CHARACTERISTICS - BC848CDW1**

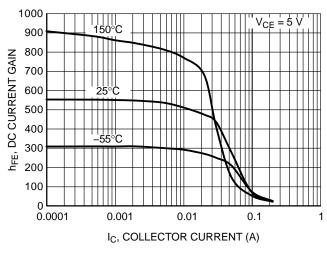


Figure 23. DC Current Gain at  $V_{CE} = 5 \text{ V}$ 

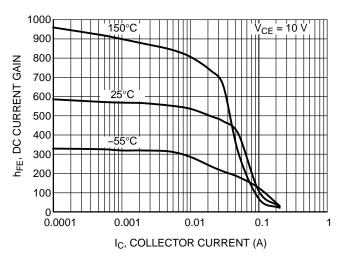
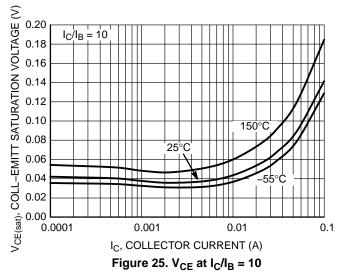


Figure 24. DC Current Gain at V<sub>CE</sub> = 10 V



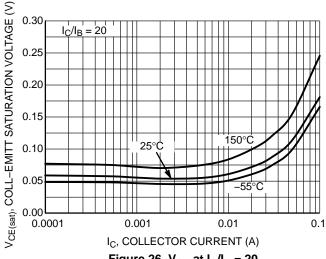


Figure 26.  $V_{CE}$  at  $I_C/I_B = 20$ 

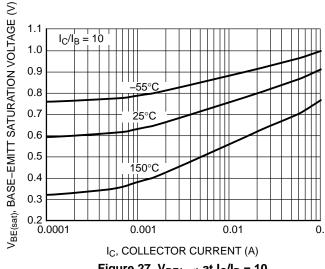


Figure 27.  $V_{BE(sat)}$  at  $I_C/I_B = 10$ 

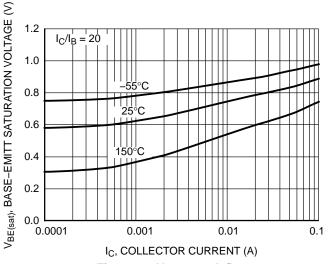


Figure 28.  $V_{BE(sat)}$  at  $I_C/I_B = 20$ 

### **TYPICAL CHARACTERISTICS - BC848CDW1**

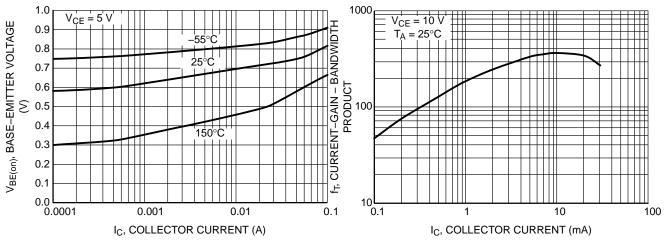


Figure 29.  $V_{BE(on)}$  at  $V_{CE} = 5 \text{ V}$ 

Figure 30. Current – Gain – Bandwidth Product

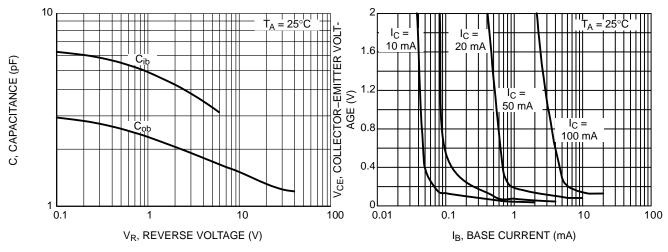


Figure 31. Capacitances

Figure 32. Collector Saturation Region

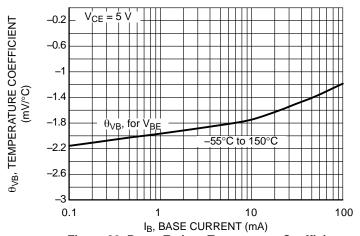


Figure 33. Base-Emitter Temperature Coefficient

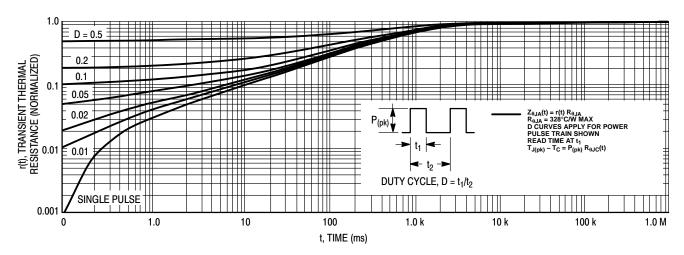


Figure 34. Thermal Response

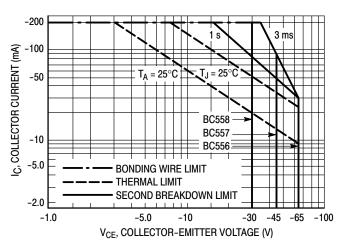


Figure 35. Active Region Safe Operating Area

The safe operating area curves indicate I<sub>C</sub>–V<sub>CE</sub> limits of the transistor that must be observed for reliable operation. Collector load lines for specific circuits must fall below the limits indicated by the applicable curve.

The data of Figure 35 is based upon  $T_{J(pk)} = 150^{\circ}C$ ;  $T_C$  or  $T_A$  is variable depending upon conditions. Pulse curves are valid for duty cycles to 10% provided  $T_{J(pk)} \le 150^{\circ}C$ .  $T_{J(pk)}$  may be calculated from the data in Figure 34. At high case or ambient temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by the secondary breakdown.

### **ORDERING INFORMATION**

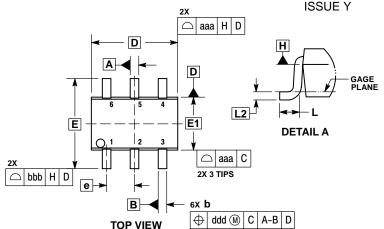
| Device           | Markings | Package              | Shipping <sup>†</sup> |
|------------------|----------|----------------------|-----------------------|
| BC846BDW1T1G     | 1B       | SOT-363<br>(Pb-Free) | 3,000 / Tape & Reel   |
| SBC846BDW1T1G*   | 1B       | SOT-363<br>(Pb-Free) | 3,000 / Tape & Reel   |
| BC847BDW1T1G     | 1F       | SOT-363<br>(Pb-Free) | 3,000 / Tape & Reel   |
| SBC847BDW1T1G*   | 1F       | SOT-363<br>(Pb-Free) | 3,000 / Tape & Reel   |
| BC847BDW1T3G     | 1F       | SOT-363<br>(Pb-Free) | 10,000 / Tape & Reel  |
| SBC847BDW1T3G*   | 1F       | SOT-363<br>(Pb-Free) | 10,000 / Tape & Reel  |
| NSVBC847BDW1T2G* | 1F       | SOT-363<br>(Pb-Free) | 10,000 / Tape & Reel  |
| BC847CDW1T1G     | 1G       | SOT-363<br>(Pb-Free) | 3,000 / Tape & Reel   |
| SBC847CDW1T1G*   | 1G       | SOT-363<br>(Pb-Free) | 3,000 / Tape & Reel   |
| BC848CDW1T1G     | 1L       | SOT-363<br>(Pb-Free) | 3,000 / Tape & Reel   |
| NSVBC848CDW1T1G* | 1L       | SOT-363<br>(Pb-Free) | 3,000 / Tape & Reel   |

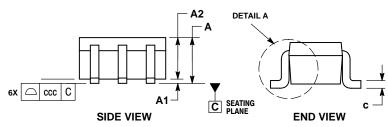
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
\*S and NSV Prefixes for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable.

#### PACKAGE DIMENSIONS

## SC-88/SC70-6/SOT-363

CASE 419B-02





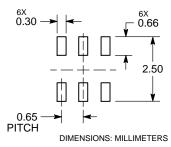
#### NOTES

- ITES:
  DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  CONTROLLING DIMENSION: MILLIMETERS.
  DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH,
  PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.20 PER END.
  DIMENSIONS D AND E1 AT THE OUTERMOST EXTREMES OF
  THE PLASTIC BODY AND DATUM H.
  DATUMS A AND B ARE DETERMINED AT DATUM H.
  DIMENSIONS D AND C APPLY TO THE FLAT SECTION OF THE
  LEAD BETWEEN 0.08 AND 0.15 FROM THE TIP.
  DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION.
  ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN

- ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 TOTAL IN EXCESS OF DIMENSION 6 AT MAXIMUM MATERIAL CONDI-TION. THE DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OF THE FOOT.

|     | MILLIMETERS |         |      | INCHES    |           |       |  |
|-----|-------------|---------|------|-----------|-----------|-------|--|
| DIM | MIN         | NOM     | MAX  | MIN       | NOM       | MAX   |  |
| Α   |             |         | 1.10 |           |           | 0.043 |  |
| A1  | 0.00        |         | 0.10 | 0.000     |           | 0.004 |  |
| A2  | 0.70        | 0.90    | 1.00 | 0.027     | 0.035     | 0.039 |  |
| b   | 0.15        | 0.20    | 0.25 | 0.006     | 0.008     | 0.010 |  |
| С   | 0.08        | 0.15    | 0.22 | 0.003     | 0.006     | 0.009 |  |
| D   | 1.80        | 2.00    | 2.20 | 0.070     | 0.078     | 0.086 |  |
| Е   | 2.00        | 2.10    | 2.20 | 0.078     | 0.082     | 0.086 |  |
| E1  | 1.15        | 1.25    | 1.35 | 0.045     | 0.049     | 0.053 |  |
| е   |             | 0.65 BS | С    | 0         | 0.026 BSC |       |  |
| L   | 0.26        | 0.36    | 0.46 | 0.010     | 0.014     | 0.018 |  |
| L2  | 0.15 BSC    |         |      | 0.006 BSC |           |       |  |
| aaa | 0.15        |         |      | 0.006     |           |       |  |
| bbb | 0.30        |         |      | 0.012     |           |       |  |
| CCC | 0.10        |         |      | 0.004     |           |       |  |
| ddd | 0.10 0.004  |         |      |           |           |       |  |

#### RECOMMENDED **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLE 1:

- PIN 1. EMITTER 2 2. BASE 2
  - 3. COLLECTOR 1
    4. EMITTER 1

  - 5. BASE 1 6. COLLECTOR 2

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BC846BDW1T1G BC847BDW1T1G BC847BDW1T3G BC847CDW1T1G BC848CDW1T1G SBC847BDW1T3G SBC846BDW1T1G NSVBC848CDW1T1G